

December 2011

# FGB7N60UNDF 600V, 7A **Short Circuit Rated IGBT**

#### **Features**

- · Short circuit rated 10us
- High current capability
- High input impedance
- Fast switching
- RoHS compliant



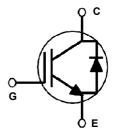
#### **Applications**

- · Home appliance inverter-driven appplication
  - Fan Motor Driver, Circulation Pump, Refrigerator, Dish Washer

## **General Description**

Using advanced NPT IGBT Technology, Fairchild's the NPT IGBTs offer the optimum performance for low power inverterdriven applications where low-losses and short circuit ruggedness feature are essential.





## **Absolute Maximum Ratings**

Symbol	Description		Ratings	Units
V <sub>CES</sub>	Collector to Emitter Voltage		600	V
V <sub>GES</sub>	Gate to Emitter Voltage		± 20	V
I <sub>C</sub>	Collector Current	@ T <sub>C</sub> = 25°C	14	A
.0	Collector Current	@ T <sub>C</sub> = 100°C	7	A
I <sub>CM (1)</sub>	Pulsed Collector Current	@ T <sub>C</sub> = 25°C	21	Α
I <sub>F</sub>	Diode Forward Current	$@ T_C = 25^{\circ}C$	7	Α
$P_{D}$	Maximum Power Dissipation	@ T <sub>C</sub> = 25°C	83	W
	Maximum Power Dissipation	@ T <sub>C</sub> = 100°C	33	W
$T_J$	Operating Junction Temperature		-55 to +150	°C
T <sub>stg</sub>	Storage Temperature Range		-55 to +150	°C
TL	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds		300	°C

**Notes:**1: Repetitive rating: Pulse width limited by max. junction temperature

### **Thermal Characteristics**

Symbol	Parameter	Тур.	Max.	Units
$R_{\theta JC}(IGBT)$	Thermal Resistance, Junction to Case		1.5	°C/W
$R_{\theta JC}(Diode)$	Thermal Resistance, Junction to Case		3.5	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (PCB Mount)(2)		40	°C/W

Notes: 2: Mounted on 1" square PCB (FR4 or G-10 material)

# **Package Marking and Ordering Information**

Device Marking Device		Package	Rel Size	Tape Width	Quantity
FGB7N60UNDF	FGB7N60UNDF	TO-263AB/D2-PAK		-	50

## Electrical Characteristics of the IGBT T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
Off Charac	teristics					
BV <sub>CES</sub>	Collector to Emitter Breakdown Voltage	$V_{GE}$ = 0V, $I_{C}$ = 250 $\mu$ A	600	-	-	V
I <sub>CES</sub>	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0V$	-	-	1	mA
I <sub>GES</sub>	G-E Leakage Current	V <sub>GE</sub> = V <sub>GES</sub> , V <sub>CE</sub> = 0V	-	-	±10	uA
On Charac	teristics					
V <sub>GE(th)</sub>	G-E Threshold Voltage	$I_C = 7mA$ , $V_{CE} = V_{GE}$	5.5	6.8	8.5	V
- (- /		I <sub>C</sub> = 7A, V <sub>GE</sub> = 15V	-	1.9	2.3	V
V <sub>CE(sat)</sub>	Collector to Emitter Saturation Voltage	I <sub>C</sub> = 7A, V <sub>GE</sub> = 15V, T <sub>C</sub> = 125°C	-	2.1	-	V
Dynamic C	haracteristics					
C <sub>ies</sub>	Input Capacitance		-	275		pF
C <sub>oes</sub>	Output Capacitance	$V_{CE} = 30V, V_{GE} = 0V,$	-	41		pF
C <sub>res</sub>	Reverse Transfer Capacitance	f = 1MHz	-	10		pF
Switching	Characteristics		1			
t <sub>d(on)</sub>	Turn-On Delay Time		-	5.9		ns
t <sub>r</sub>	Rise Time		-	4.2		ns
t <sub>d(off)</sub>	Turn-Off Delay Time	V <sub>CC</sub> = 400V, I <sub>C</sub> = 7A,	-	32.3		ns
t <sub>f</sub>	Fall Time	$R_G = 10\Omega, V_{GE} = 15V,$	-	68	89	ns
E <sub>on</sub>	Turn-On Switching Loss	Inductive Load, T <sub>C</sub> = 25°C	-	99		uJ
E <sub>off</sub>	Turn-Off Switching Loss		-	104		uJ
E <sub>ts</sub>	Total Switching Loss		-	203		uJ
t <sub>d(on)</sub>	Turn-On Delay Time		-	6		ns
t <sub>r</sub>	Rise Time		-	4.3		ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{CC} = 400V, I_{C} = 7A,$	-	33.8		ns
t <sub>f</sub>	Fall Time	$R_G = 10\Omega, V_{GE} = 15V,$	-	113		ns
E <sub>on</sub>	Turn-On Switching Loss	Inductive Load, T <sub>C</sub> = 125°C	-	181		uJ
E <sub>off</sub>	Turn-Off Switching Loss		-	144		uJ
E <sub>ts</sub>	Total Switching Loss		-	325		uJ
T <sub>sc</sub>	Short Circuit Withstand Time	$V_{CC} = 350V$ , $R_G = 100\Omega$ , $V_{GE} = 15V$ , $T_C = 150^{\circ}C$	10			us

# Electrical Characteristics of the IGBT $T_C = 25^{\circ}C$ unless otherwise noted

$Q_g$	Total Gate Charge		-	18	-	nC
$Q_{ge}$	Gate to Emitter Charge	V <sub>CE</sub> = 400V, I <sub>C</sub> = 7A, V <sub>GE</sub> = 15V		3	-	nC
Q <sub>gc</sub>	Gate to Collector Charge	VGE - 10V	-	13	-	nC

# Electrical Characteristics of the Diode $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions		Min.	Тур.	Max	Units
V <sub>FM</sub> Dio	Diode Forward Voltage	=   / A	T <sub>C</sub> = 25°C	-	1.7	2.2	V
			T <sub>C</sub> = 125°C	-	1.6		
t	t <sub>rr</sub> Diode Reverse Recovery Time  Q <sub>rr</sub> Diode Reverse Recovery Charge	-I <sub>F</sub> =7A, dI <sub>F</sub> /dt = 200A/μs	$T_C = 25^{\circ}C$	-	32.3		ns
11			$T_{\rm C} = 125^{\rm o}{\rm C}$	-	70		
Q.,,			T <sub>C</sub> = 25°C	-	59		nC
~11			$T_{\rm C}$ = 125 $^{\rm o}$ C	ı	172	-	

Figure 1. Typical Output Characteristics

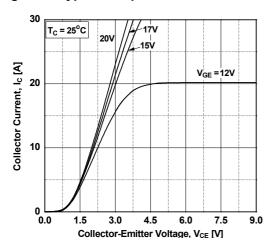


Figure 3. Typical Saturation Voltage Characteristics

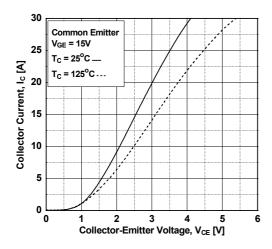
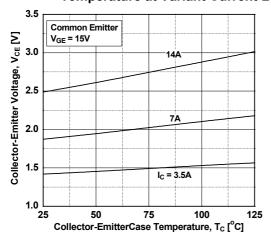
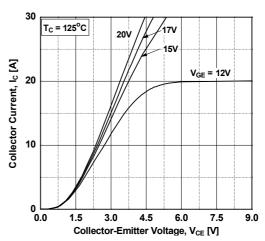


Figure 5. Saturation Voltage vs. Case
Temperature at Variant Current Level



**Figure 2. Typical Output Characteristics** 



**Figure 4. Transfer Characteristics** 

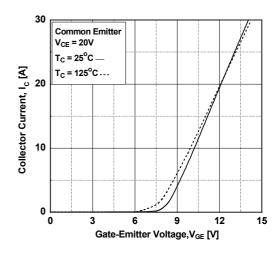


Figure 6. Saturation Voltage vs. V<sub>GE</sub>

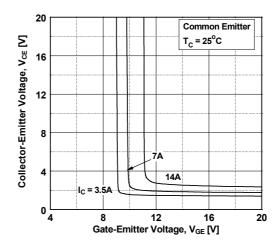


Figure 7. Saturation Voltage vs. V<sub>GE</sub>

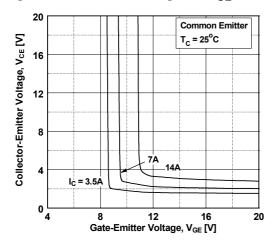


Figure 9. Gate charge Characteristics

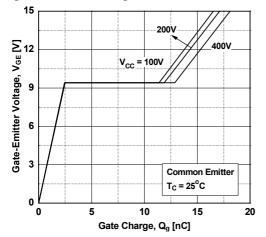
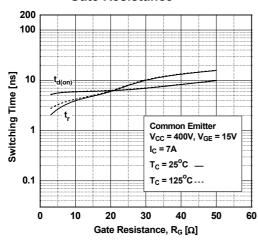


Figure 11. Turn-on Characteristics vs.
Gate Resistance



**Figure 8. Capacitance Characteristics** 

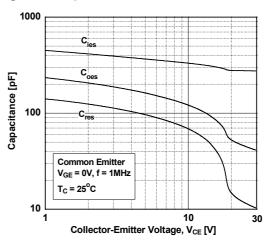


Figure 10. SOA Characteristics

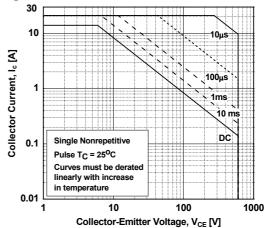


Figure 12. Turn-off Characteristics vs. Gate Resistance

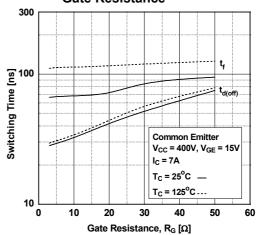


Figure 13. Turn-on Characteristics vs. Collector Current

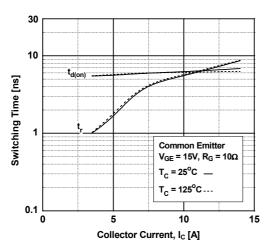


Figure 15. Switching Loss vs.

Gate Resistance

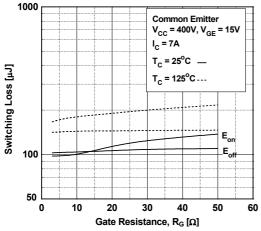


Figure 17. Turn off Switching SOA Characteristics

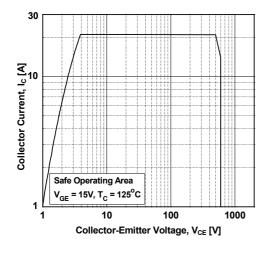


Figure 14. Turn-off Characteristics vs.
Collector Current

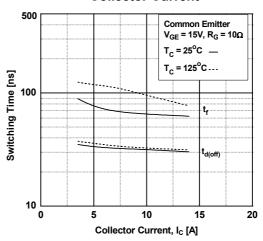
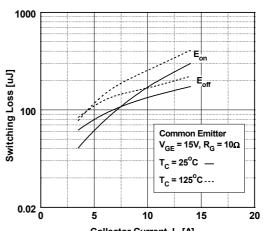


Figure 16. Switching Loss vs Collector Current



Collector Current, I<sub>C</sub> [A] Figure 18. Forward Characteristics

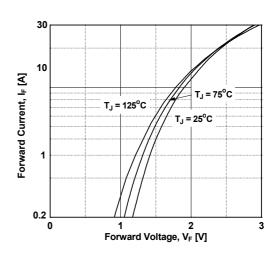


Figure 19. Reverse Recovery Current

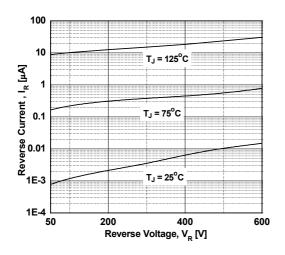


Figure 20. Stored Charge

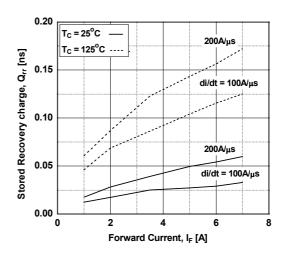


Figure 21. Reverse Recovery Time

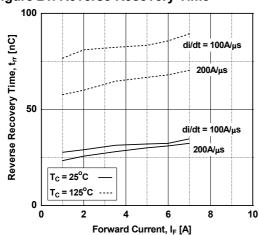
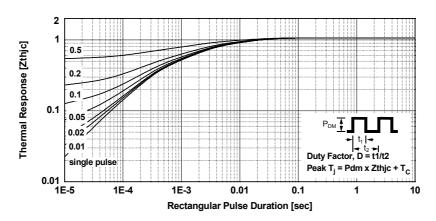
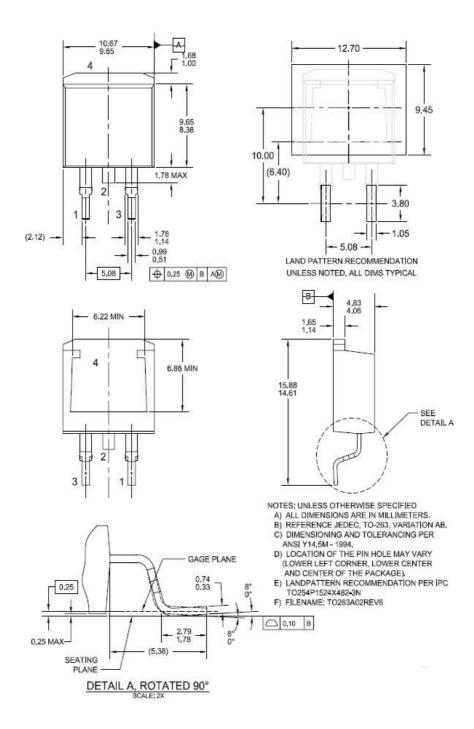


Figure 22.Transient Thermal Impedance of IGBT



#### **Mechanical Dimensions**

# TO-263AB/D<sup>2</sup>-PAK







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